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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number		10551305
	Filing Date		2006-11-14
	First Named Inventor	Nancy Dean	
	Art Unit	2823	
	Examiner Name	William D. Coleman	
Attorney Docket Number		H0004275.84418 US2 - 4018	

U.S.PATENTS						
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Examiner Initial*	Cite No	Publication Number	Kind Code¹	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear
/W.D.C./	1	20050011656	A1	2005-01-20	Maxwell Technologies, Inc.	
/W.D.C./	2	20050012080	A1	2005-01-20	Quantum Leap Packaging, Inc.	
/W.D.C./	3	20050012186	A1	2005-01-20	Quantum Leap Packaging, Inc.	
/W.D.C./	4	20050016750	A1	2005-01-27	Quantum Leap Packaging, Inc.	
/W.D.C./	5	20050029657	A1	2005-02-10	Broadcom Corporation	

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/W.D.C./	6	20050041406	A1	2005-02-24	James Christopher Matayabas Jr., et al.	
/W.D.C./	7	20050051893	A1	2005-03-10	Taiwan Semiconductor Manufacturing Co.	
/W.D.C./	8	20050062143	A1	2005-03-24	LSI Logic Corporation	
/W.D.C./	9	20050062154	A1	2005-03-24	International Business Machines Corporation	
/W.D.C./	10	20050077000	A1	2005-04-14	Julian Norley, et al.	
/W.D.C./	11	20050079304	A1	2005-04-14	Timothy Clovesko, et al.	
/W.D.C./	12	20050079355	A1	2005-04-14	Timothy Clovesko, et al.	
/W.D.C./	13	20050110140	A1	2005-05-26	Taiwan Semiconductor Manufacturing Co.	
/W.D.C./	14	20050142317	A1	2005-06-30	Timothy Clovesko, et al.	
/W.D.C./	15	20050183444	A1	2005-08-25	Mark Munch, et al.	
/W.D.C./	16	20050189568	A1	2005-09-01	International Business Machines Corporation	

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/W.D.C./	17	20050189647	A1	2005-09-01	Chien-Min Sung	
/W.D.C./	18	20050241801	A1	2005-11-03	Jonathan E. Mitchell, et al.	
/W.D.C./	19	20050250252	A1	2005-11-10	Yuan Li	
/W.D.C./	20	20060001152	A1	2006-01-05	Phoenix Precision Technology Corporation	
/W.D.C./	21	20060019429	A1	2006-01-26	ChipPAC, Inc.	
/W.D.C./	22	20060021734	A1	2006-02-02	Shih-Ying Chang, et al.	
/W.D.C./	23	20060033203	A1	2006-02-16	HON HAI Precision Industry Co., Ltd.	
/W.D.C./	24	20060044749	A1	2006-03-02	Robert S. Pauley, et al.	
/W.D.C./	25	20060060963	A1	2006-03-23	Taiwan Semiconductor Manufacturing Company, Ltd.	
/W.D.C./	26	20060061965	A1	2006-03-23	Visteon Global Technologies, Inc.	
/W.D.C./	27	20060091532	A1	2006-05-04	Chien-Min Sung	

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/W.D.C./	28	20060098413	A1	2006-05-11	Joseph P. Capp	
/W.D.C./	29	20060109630	A1	2006-05-25	Evan George Colgan, et al.	
/W.D.C./	30	20060113546	A1	2006-06-01	Chien-Min Sung	
/W.D.C./	31	20060118947	A1	2006-06-08	Taiwan Semiconductor Manufacturing Co., Ltd.	
/W.D.C./	32	20060120054	A1	2006-06-08	Endress & Hauser Gmbh & Co. KG	
/W.D.C./	33	20060131711	A1	2006-06-22	Yoshihiko Ino	
/W.D.C./	34	20060138622	A1	2006-06-29	Daoqiang Lu, et al	
/W.D.C./	35	20060138643	A1	2006-06-29	Daoqiang Lu, et al	
/W.D.C./	36	20060145316	A1	2006-07-06	Sang-uk Kim, et al.	
/W.D.C./	37	20060145320	A1	2006-07-06	Pete D. Vogt	
/W.D.C./	38	20060151873	A1	2006-07-13	Mark Fery, et al.	

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/W.D.C./	39	20060171123	A1	2006-08-03	Tyco Electronics Corporation	
/W.D.C./	40	20060182385	A1	2006-08-17	Samsung Electro-Mechanics Co., Ltd.	
/W.D.C./	41	20060185823	A1	2006-08-24	John G. Thayer, et al.	
/W.D.C./	42	20060191707	A1	2006-08-31	NGK Insulators, Ltd.	
/W.D.C./	43	20060214283	A1	2006-09-28	Sang-Uk Kim, et al.	
/W.D.C./	44	20060214295	A1	2006-09-28	Katsufumi Tanaka	
/W.D.C./	45	20060220226	A1	2006-10-05	Intel Corporation	
/W.D.C./	46	20070035012	A1	2007-02-15	Carl L. Deppisch, et al.	
/W.D.C./	47	20080096324	A1	2008-04-24	Daoqiang Lu, et al.	
/W.D.C./	48	20080174007	A1	2008-07-24	Intel Corporation	
/W.D.C./	49	20080185713	A1	2008-08-07	Intel Corporation	

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/W.D.C./	50	20030056938	A1	2003-03-27	Kevin A. McCullough	
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FOREIGN PATENT DOCUMENTS

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